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TMS 2017
146th Annual Meeting & Exhibition



February 26 – March 2, 2017
San Diego, California, USA

PHASE STABILITY, PHASE TRANSFORMATIONS, AND REACTIVE PHASE FORMATION IN ELECTRONIC MATERIALS XVI

This is the 16th in a series of TMS symposia addressing the stability, transformation, and formation of phases during the fabrication, processing, and utilization of electronic materials and devices.

Topics of interest range from microelectronic technologies to advanced energy technologies, including phase stability, transformation, formation, and morphological evolution of electronic packaging materials, interconnection materials, integrated circuit materials, and optoelectronic materials, as well as energy storage and generating materials.

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Selected papers from this symposium may be published in the TMS journal, *Journal of Electronic Materials*.

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